



11NK90Z

POWER MOSFET

11A, 900V N-CHANNEL POWER MOSFET

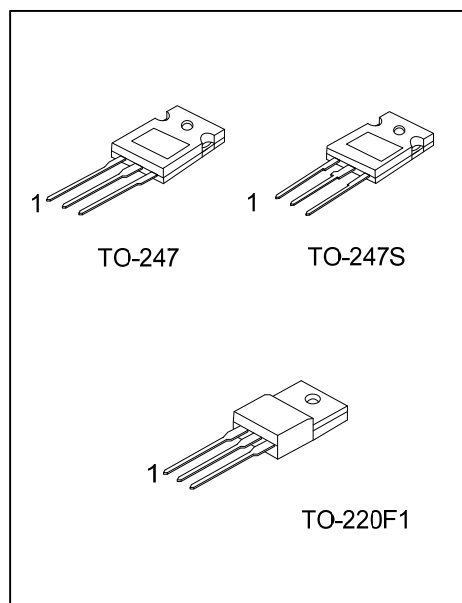
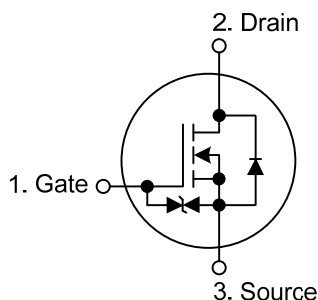
DESCRIPTION

The UTC **11NK90Z** is a silicon N-channel MOSFET, it uses UTC's advanced technology to provide the customers with a minimum on state resistance, high switching speed and low gate charge.

FEATURES

- * $R_{DS(ON)} \leq 1.1 \Omega$ @ $V_{GS}=10V$, $I_D=5.5A$
- * High switching speed
- * Low input capacitance
- * With ESD protection

SYMBOL



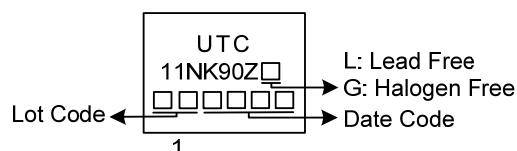
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
11NK90ZL-TF1-T	11NK90ZG-TF1-T	TO-220F1	G	D	S	Tube
11NK90ZL-T47-T	11NK90ZG-T47-T	TO-247	G	D	S	Tube
11NK90ZL-T47S-T	11NK90ZG-T47S-T	TO-247S	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

11NK90ZG-TF1-T	(1)Packing Type	(1) T: Tube
	(2)Package Type	(2) TF1: TO-220F1, T47: TO-247, T47S: TO-247S
	(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

MARKING



■ ABSOLUTE MAXIMUM RATING ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DS}	900	V
Gate-Source Voltage		V_{GS}	± 20	V
Drain Current	DC	I_D	11	A
	Pulsed (Note 2)	I_{DM}	33	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	1250	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.1	V/ns
Power Dissipation	TO-220F1	P_D	45	W
	TO-247/TO-247S		200	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature Range		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L=100\text{mH}$, $I_{AS}=5.0\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^{\circ}\text{C}$.

4. $I_{SD} \leq 11\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DS}$, Starting $T_J=25^{\circ}\text{C}$.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-247/TO-247S		50	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220F1	θ_{JC}	2.77	$^{\circ}\text{C}/\text{W}$
	TO-247/TO-247S		0.625	$^{\circ}\text{C}/\text{W}$

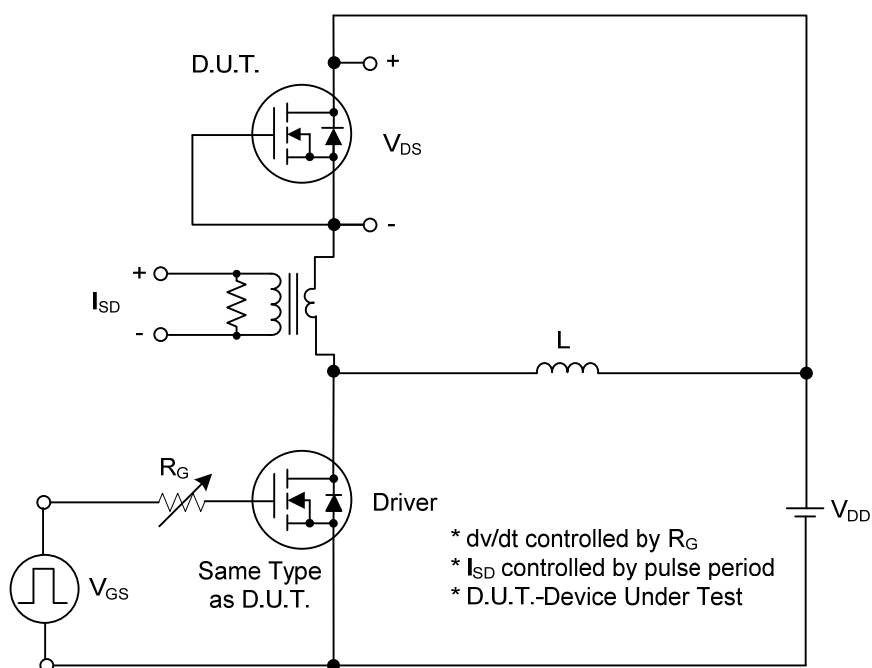
■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	900			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =900V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =+20V, V _{DS} =0V			+10	μA
	Reverse		V _{GS} =-20V, V _{DS} =0V			-10	μA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} = V _{GS} , I _D =250μA	3.0		5.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =5.5A			1.1	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =50V, f=1.0MHz		2630		pF
Output Capacitance		C _{OSS}			145		pF
Reverse Transfer Capacitance		C _{RSS}			19		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q _G	V _{DS} =720V, V _{GS} =10V, I _D =11A (Note 1, 2)		84		nC
Gate to Source Charge		Q _{GS}			27		nC
Gate to Drain Charge		Q _{GD}			30		nC
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =100V, V _{GS} =10V, I _D =11A, R _G =25Ω (Note 1, 2)		46		ns
Rise Time		t _R			27		ns
Turn-OFF Delay Time		t _{D(OFF)}			162		ns
Fall-Time		t _F			58		ns
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Continuous Drain-Source Diode Forward Current		I _S				11	A
Maximum Pulsed Drain-Source Diode Forward Current		I _{SM}				33	A
Diode Forward Voltage		V _{SD}	I _F =11A, V _{GS} =0V			1.4	V
Reverse Recovery Time		t _{rr}	I _S =11A, V _{GS} =0V,		920		ns
Reverse Recovery Charge (Note 1)		Q _{rr}	dl _F /dt = 100 A/μs		10		uC

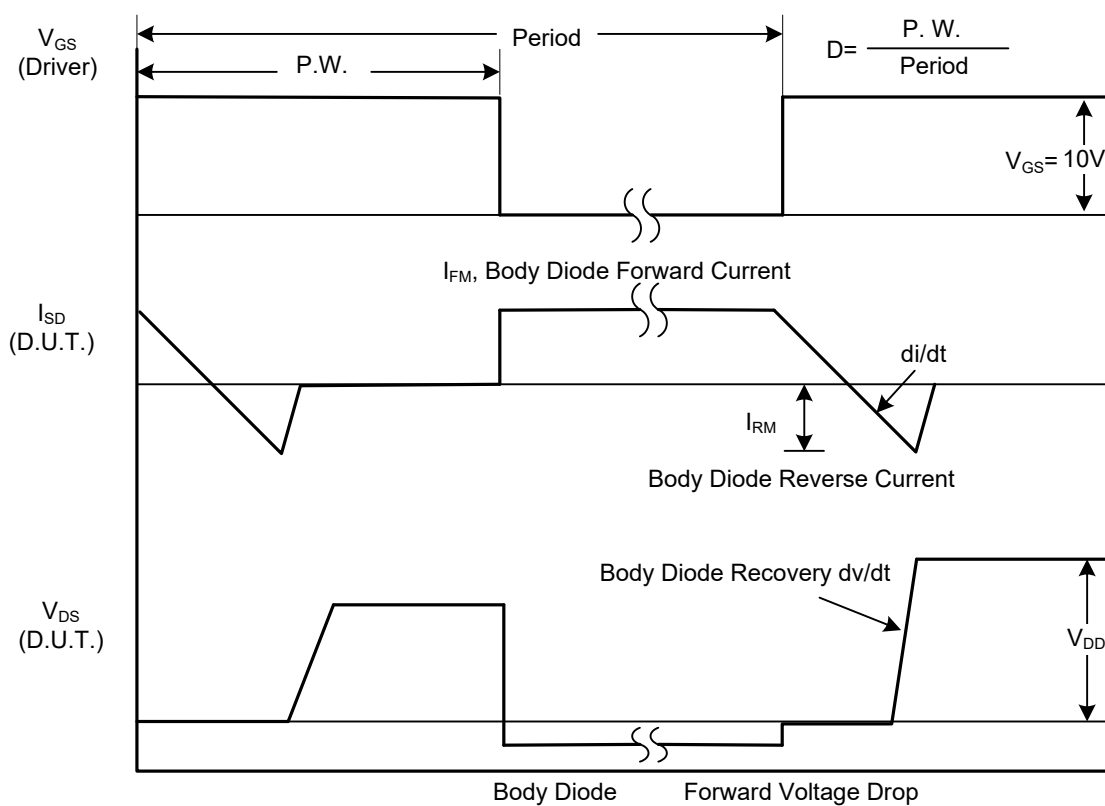
Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

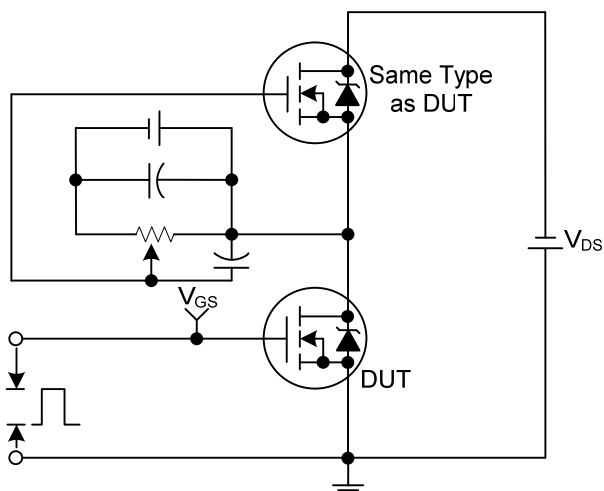


Peak Diode Recovery dv/dt Test Circuit

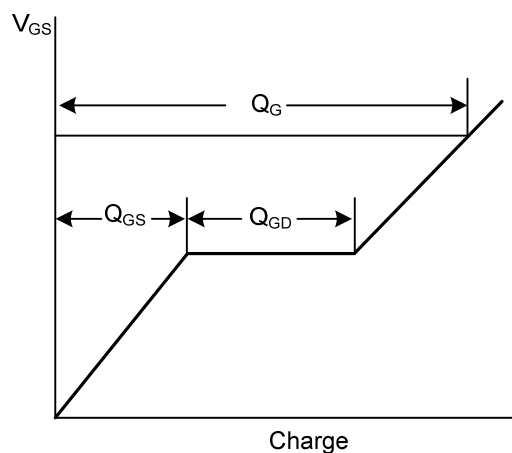


Peak Diode Recovery dv/dt Waveforms

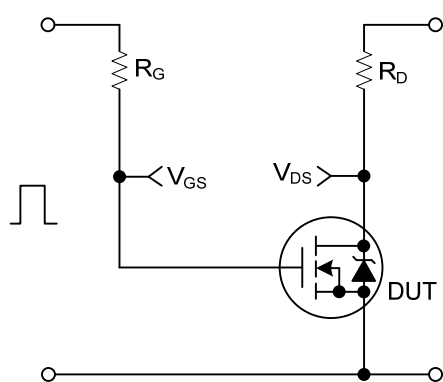
■ TEST CIRCUITS AND WAVEFORMS



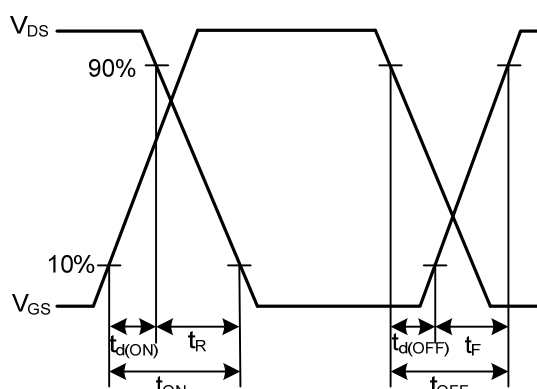
Gate Charge Test Circuit



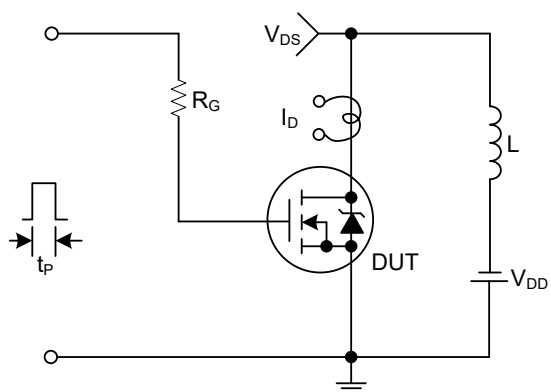
Gate Charge Waveforms



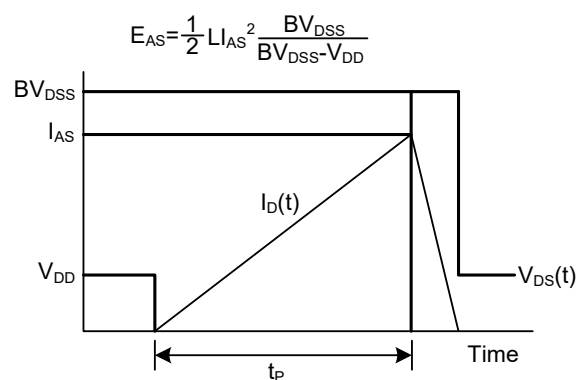
Resistive Switching Test Circuit



Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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